



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(on) Max	I _D T _C = +25°C
-40V	$11m\Omega$ @ V _{GS} = -10V	-35A
-4 0V	$15m\Omega @ V_{GS} = -4.5V$	-30A

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- · Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP4015SK3Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

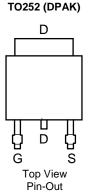
- DC-DC converters
- Power-management functions
- Backlighting

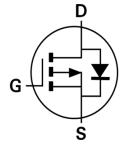
Mechanical Data

- Package: TO252
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish—Matte Tin Finish Annealed over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208(3)
- Weight: 0.33 grams (Approximate)









Equivalent Circuit

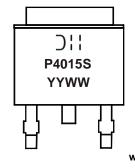
Ordering Information (Note 4)

Port Number	Pookage	Packing		
Part Number	Package	Qty.	Carrier	
DMP4015SK3Q-13	TO252 (DPAK)	2500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Oll = Manufacturer's Marking P4015S = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 23 = 2023) WW = Week (01 to 53)



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	-40	V		
Gate-Source Voltage	Vgss	±25	V		
Continuous Drain Current (Note 5) V _{GS} = -10V	Steady State	Tc = +25°C Tc = +70°C	I _D	-35 -27	А
Continuous Prain Current (Note 5) \/os 40\/	Steady State	$T_A = +25$ °C $T_A = +70$ °C	lo	-14 -11	А
t < 10s		$T_A = +25$ °C $T_A = +70$ °C	lo	-22 -18	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	-100	Α		
Maximum Body Diode Forward Current (Note 5)	Is	-5.5	Α		
Avalanche Current L = 1mH	I _{AS}	-22	Α		
Avalanche Energy L = 1mH	Eas	242	mJ		

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	0-	3.5	W
Total Power Dissipation (Note 5)	$T_A = +70$ °C	PD	2.2	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Б	36	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	RθJA	15	
Thermal Resistance, Junction to Case (Note 5)	Steady State	Rejc	4.5	
Operating and Storage Temperature Range	$T_{J,}T_{STG}$	-55 to +150	°C	

Electrical Characteristics (@ TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BVDSS	-40	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -40V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	Vgs(TH)	-1.5	-2	-2.5	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	D	_	7	11	mΩ	$V_{GS} = -10V, I_{D} = -9.8A$	
Static Drain-Source On-Resistance	RDS(ON)	_	9	15	11122	$V_{GS} = -4.5V$, $I_D = -9.8A$	
Forward Transfer Admittance	Y _{fs}	_	26	_	S	$V_{DS} = -20V$, $I_{D} = -9.8A$	
Diode Forward Voltage	VsD	_	-0.7	-1	V	$V_{GS} = 0V$, $I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss	_	4,234	_		V _{DS} = -20V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	_	1,036	_	pF		
Reverse Transfer Capacitance	Crss	_	526	_		I = IIVIHZ	
Gate Resistance	Rg	_	7.77	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	47.5	_			
Gate-Source Charge	Qgs	_	14.2	_	nC	V _{DS} = -20V, V _{GS} = -5V I _D = -9.8A	
Gate-Drain Charge	Qgd	_	13.5	_			
Turn-On Delay Time	tD(ON)	_	13.2	_		V _G S = -10V, V _{DD} = -20V,	
Turn-On Rise Time	t _R	_	10	_			
Turn-Off Delay Time	t _{D(OFF)}	_	302.7	_	ns	$R_G = 6\Omega$, $I_D = -1A$	
Turn-Off Fall Time	tF	_	137.9	_			

Notes: 5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing.



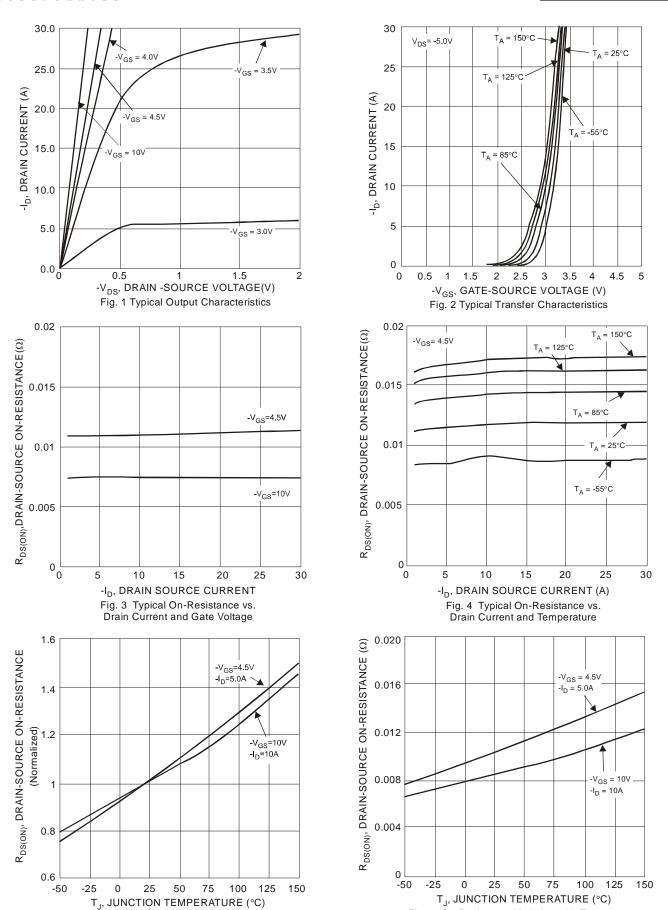


Fig. 5 On-Resistance Variation with Temperature

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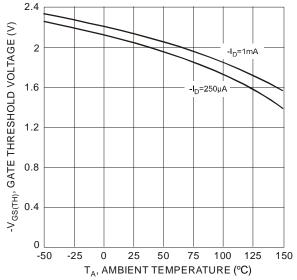
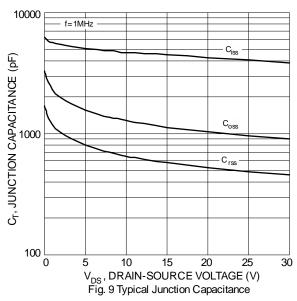
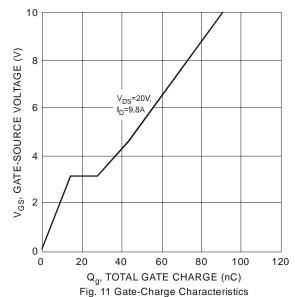
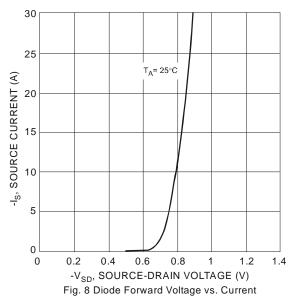


Fig. 7 Gate Threshold Variation vs. Ambient Temperature







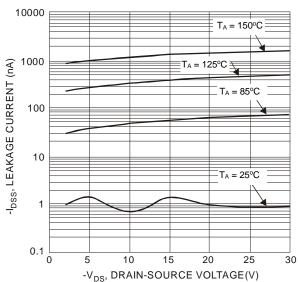


Fig. 10 Typical Drain-Source Leakage Current vs. Voltage

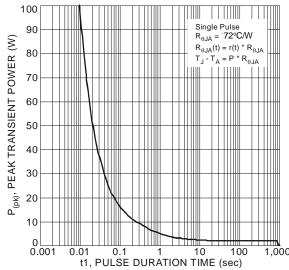
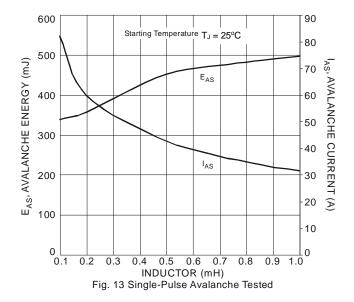
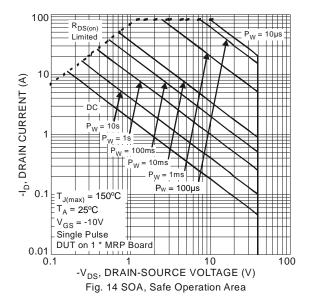
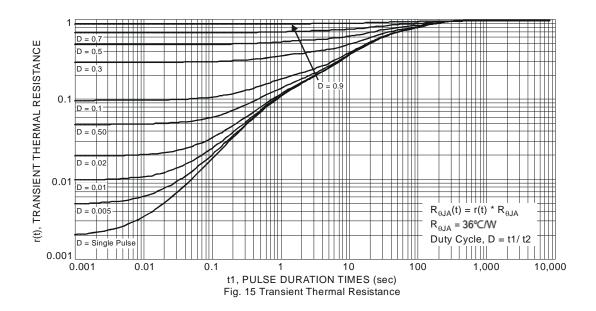


Fig. 12 Single Pulse Maximum Power Dissipation





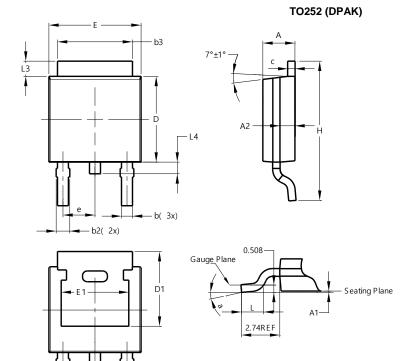






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

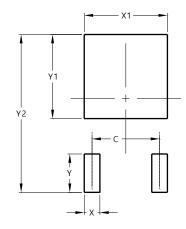


TO252 (DPAK)					
Dim	Min Max		Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.50	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21				
е	2.286 BSC				
Е	6.45	6.70	6.58		
E1	4.32				
Н	9.40	10.41	9.91		
٦	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°			
All Dimensions in mm					

Suggested Pad Layout

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

TO252 (DPAK)



	r			
Dimensions	Value (in mm)			
С	4.572			
X	1.060			
X1	5.632			
Y	2.600			
Y1	5.700			
Y2	10 700			



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